

IND108W Hornet: Non-Isolated DC-DC Voltage Regulator Modules

12Vdc input; 3Vdc to 8Vdc output; 80W Max Power



Applications

- Industrial Equipment
- ✓ Control Boards
- Test Equipment

Electrical Features

- 12V Input voltage with ±20% Tolerance
- Output voltage programmable from 3Vdc to 8Vdc via external resistor
- Remote On/Off for optional external control
- Fixed switching frequency
- Sync Capability
- Output overcurrent protection (non-latching)

Process and Safety



Mechanical Features

- Small size: 33 mm x 13.46 mm x 10 mm (1.3 in x 0.53 in x 0.39 in)
- Operating range: -40°C to 105°C ambient
- Operating shock to 40G per Mil Std. 810G, Method 516.4 Procedure I
- Operating vibration per Mil Std. 810G, Method 514.5 Procedure I
- Qualified for 1000h High Temperature Operating Bias, 1000h 85RH/85°C Temperature, Humidity and Bias, 700 cycle -40 to 125°C thermal cycling.
- ANSI/UL* 62368-1 and CAN/CSA⁺ C22.2 No. 62368-1 Recognized, DIN VDE[‡] 0868-1/A11:2017 (EN62368-1:2014/A11:2017)
- ISO** 9001 and ISO 14001 certified manufacturing facilities.
- Compliant to RoHS Directive 2011/65/EU and amended Directive (EU) 2015/863
- Compliant to REACH Directive (EC) No 1907/2006
- Compatible in a Pb-free or SnPb reflow environment.
- Suitable for aqueous clean.
- Suitable for conformal coating with dip and vapor deposition. Conformal coating can provide the protection to meet Salt Fog Test per IEC 60068-2-52 (Severity 3) and Mixed Gas Flow test per Telcordia GR-3108 Outdoor Levels.
- 3 year warranty.

Device Code	Input Voltage	Output Voltage	Output Current (Max.)	On/Off Logic	Comcode	
IND108W	9.6 – 14.4Vdc	3.0 – 8.0Vdc	12A(@3Vout)	Negative	1600102904A	

Thermal Performance

Full rated output with natural convection up to 82°C at 3.3Vout and up to 86°C at 5Vout. Thermal curves for both voltages below.





Electrical Specifications

Parameter	Device	Symbol	Min	Тур	Max	Unit
Operating Input Voltage	All	VIN	9.6	12	14.4	Vdc
External Capacitance, Ceramic $ESR \ge 1 m\Omega$	All	C _{O, max}		—	100*	μF
Efficiency $12V_{INDC}$, $T_A=25^{\circ}C$, I_o as per Figure 2		η	91(3.3Vo), 93(5Vo)		%	
Switching Frequency	All	f _{sw}		308	_	kHz
Output Voltage (Over all line, load, and temperature conditions)	All	VO, set	-2.5	_	+2.5	% VO, set
On/Off Logic High (MODULE OFF) Input High Voltage	All	VIH	1.8		36	Vdc
On/ Off Logic Low (MODULE ON) Input Low Voltage	All	VIL	-0.2	_	0.3	Vdc
Frequency Synchronization						
Synchronization Frequency Range			fSW		1.1 fSW	kHz
Input high voltage			2			V
Input low voltage					0.8	V
Input Current, SYNC					10	nA
Minimum SYNC Pulse Width			50			ns
Additional External Capacitance possible using Tunable Loop	•			•		•

Characteristic Curves

The following figures provide typical characteristics for the IND108W Hornet at 25°C.



Figure 1. Output Ripple Voltage for various output voltages and external caps @12Vin. Additional Decoupling cap of 0.01uF used on input and output side



Figure 2. Graph showing maximum output current capability at different output voltages.

Use electrical profile in Figure 2 for determining baseline output current for a specific voltage. Then thermal curves.

Trim

Rtrim for a desired output voltage, should be as per the following table. The formula in the last column helps determine Rtrim for other voltages.

Vo (V)	3.3	5.0	6	8	$Rtrim = \begin{bmatrix} 70 \\ \hline \end{pmatrix} k\Omega$
Rtrim(kΩ)	26.92	16.27	13.2	9.59	$\left[\frac{VO}{VO} - 0.7 \right]^{KS2}$

Safety Considerations

For safety agency approval, the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards listed on the first page of this document. For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV) or ES1, the input must meet SELV/ES1 requirements. The power module has extra-



low voltage (ELV) outputs when all inputs are ELV. The input to these units is to be provided with a fast-acting fuse with a maximum rating of 8A in the positive input lead.

Tunable Loop

The module is designed for 47uF capacitor on its output. For applications where more than 47uF capacitors would be used on the output, an additional Resistor (Rtune) and Capacitor (Ctune) would be required in the circuit schematic to compensate for the additional capacitance. The placement is between the Sense+ pin and Trim pin as per figure below:



The recommended values for Rtune and Ctune for different amounts of external capacitance are as per the table below:

The regulator switching frequency can be synchronized to

signal applied to the SYNC pin of the module as shown in Fig. 4, with the converter being synchronized by the rising edge of the external signal. The Electrical Specifications table specifies the requirements of the external SYNC

signal. If the SYNC pin is not used, the module should free

run at the default switching frequency. If synchronization

is not being used, connect the SYNC pin to GND.

a signal with an external frequency within a specified range. Synchronization can be done by using the external

Со	5 x 22μF	<mark>6 x 22μ</mark> F	<mark>7 x 22μ</mark> F	8 x 22μF	10 x 22μF
R _{TUNE}	300Ω	300Ω	240Ω	240Ω	240Ω
C _{TUNE}	2700pF	3300pF	3900pF	4700pF	6800pF

Figure 3. Circuit diagram showing connection of R_{TUNE} and C_{TUNE} to tune the control loop of the module.

Synchronization (SYNC)



Figure 4. External source connections to synchronize switching frequency of the module.

Recommended Pad Layout

Dimensions are in millimeters and (inches).

Tolerances: x.x mm \pm 0.5 mm (x.xx in \pm 0.02 in.) [unless otherwise indicated] x.xx mm \pm 0.25 mm (x.xxx in \pm 0.010 in.)





Nozzle Recommendations

The minimum recommended inside nozzle diameter for reliable operation is 3mm. The maximum nozzle outer diameter, which will safely fit within the allowable component spacing, is 7 mm.

Bottom Side / First Side Assembly

This module is not recommended for assembly on the bottom side of a customer board. If such an assembly is attempted, components may fall off the module during the second reflow process

Lead Free Soldering

The modules are lead-free (Pb-free) and RoHS compliant and fully compatible in a Pb-free soldering process. Failure to observe the instructions below may result in the failure of or cause damage to the modules and can adversely affect long-term reliability

MSL Rating

The modules have a MSL rating of 2a.

Pb-free Reflow Profile

Power Systems will comply with J-STD-020 Rev. D (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. The suggested Pb-free solder paste is Sn/Ag/Cu (SAC).

The following profile is the recommended linear reflow profile using Sn/Ag/Cu solder. Soldering outside of the recommended profile requires testing to verify results and performance.

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Storage and Handling

J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices) is recommended. Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of \leq 30°C and 60% relative humidity varies according to the MSL rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions: < 40° C, < 90% relative humidity.

Post Solder Cleaning and Drying Considerations

Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly

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